

## 10A, 750V N-CHANNEL POWER MOSFET

### ■ DESCRIPTION

The UTC **10N75** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **10N75** is universally applied in high efficiency switch mode power supply, active power factor correction, electronic lamp based on half bridge topology.

### ■ FEATURES

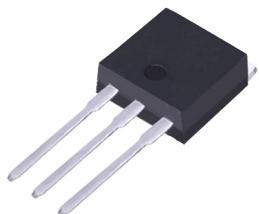
- \*  $R_{DS(on)}=1.3\Omega$  @ $V_{GS}=10V$
- \* High switching speed
- \* Improved dv/dt capability
- \* 100% avalanche tested



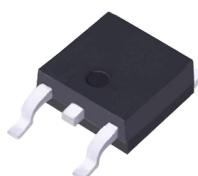
TO-220



TO-220F



TO-262



TO-263



TO-251



TO-252

■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	750	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	10	A
	Pulsed (Note 2)	$I_{DM}$	40	A
Avalanche Current (Note 2)		$I_{AR}$	10	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	920	mJ
	Repetitive (Note 2)	$E_{AR}$	24	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation	TO-220	$P_D$	156	W
	TO-220F/TO-220F1		50	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55~+150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.  
 Note: 2. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L=17.3\text{mH}$ ,  $I_{AS}=10\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

4.  $I_{SD} \leq 10\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F/TO-220F1		62.5	$^\circ\text{C/W}$
Junction to Case	TO-220	$\theta_{JC}$	0.8	$^\circ\text{C/W}$
	TO-220F/TO-220F1		2.5	$^\circ\text{C/W}$

■ ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	750			V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$ , Referenced to $25^\circ\text{C}$		0.98		$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current		$I_{\text{DSS}}$	$V_{\text{DS}}=750\text{V}, V_{\text{GS}}=0\text{V}$		10	$\mu\text{A}$
			$V_{\text{DS}}=640\text{V}, T_C=125^\circ\text{C}$		100	$\mu\text{A}$
Gate-Source Leakage Current	Forward	$I_{\text{GSS}}$	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=30\text{V}$		100	nA
	Reverse		$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=-30\text{V}$		-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5\text{A}$		0.93	1.3	$\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=50\text{V}, I_{\text{D}}=5.0\text{A}$ (Note 1)		5.8		S
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		2150	2800	pF
Output Capacitance	$C_{\text{OSS}}$			180	230	pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			15	20	pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	$Q_G$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=10\text{A}$ (Note 1, 2)		45	58	nC
Gate-Source Charge	$Q_{\text{GS}}$			13.5		nC
Gate-Drain Charge	$Q_{\text{GD}}$			17		nC
Turn-ON Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}}=350\text{V}, I_{\text{D}}=10\text{A}, R_{\text{G}}=25\Omega$ $V_{\text{DS}}=10\text{V}$ (Note 1, 2)		50	110	ns
Turn-ON Rise Time	$t_R$			130	270	ns
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			90	190	ns
Turn-OFF Fall Time	$t_F$			80	170	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				10.0	A
Maximum Body-Diode Pulsed Current	$I_{\text{SM}}$				40.0	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$I_S = 10.0\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	$t_{\text{rr}}$	$V_{\text{GS}}=0\text{V}, I_S=10.0\text{A},$		730		ns
Body Diode Reverse Recovery Charge	$Q_{\text{RR}}$	$dI_F/dt=100\text{A}/\mu\text{s}$ (Note 1)		10.9		$\mu\text{C}$

Note: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ 

2. Essentially independent of operating temperature